

Features

Ultra low capacitance: 0.3pF typical (I/O to I/O)

Ultra low leakage: nA level

Low operating voltage: 5V

Low clamping voltage

Up to 4 data lines and one power line protects

Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±30kV Contact discharge: ±25kV

- IEC61000-4-4 (EFT) 40A (5/50ns)

- IEC61000-4-5 (Lightning): 3A(8/20µs)

ROHS Compliant

Ordering Information

Part Number	Qty per Reel	Reel Size	
SRV05-4	3000	7"	

Mechanical Characteristics

Package: SOT23-6 Lead Finish: Matte Tin

Case Material: "Green" Molding Compound.

UL Flammability Classification Rating 94V-0

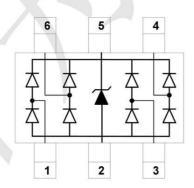
Moisture Sensitivity: Level 1 per J-STD-020



Applications

- USB 2.0 and USB 3.0 Ports
- USB OTG
- Digital video interface(DVI)
- Monitor and Flat Panel Displays
- PCI Express and Serial SATA Ports
- **Gigabit Ethernet**
- IEEE 1394 firewire ports
- Consumer products (STB, DVD, DSC, DVC...)

Dimensions and Pin Configuration



Circuit and Pin Schematic



Absolute Maximum Ratings (Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp=8/20µs)	Ppp	60	W
Peak Pulse Current (tp=8/20µs)	IPP	3	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	VESD	±30 ±25	kV
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			5	V	Any I/O pin to ground
Breakdown Voltage	VBR	6			V	IT = 1mA, any I/O pin to ground
Reverse Leakage Current	IR			0.5	μΑ	VRWM = 5V, any I/O pin to ground
Clamping Voltage	Vc			15	V	IPP = 1A (8 x 20µs pulse) any I/O pin to ground
Clamping Voltage	Vc			20	V	IPP = 3A (8 x 20µs pulse) any I/O pin to ground
Junction Capacitance	Cı		0.3	0.4	pF	VR = 0V, f = 1MHz, between I/O pins
Junction Capacitance	Сл			0.8	pF	VR = 0V, f = 1MHz, any I/O pin to ground

Note 1: I/O pins are Pin 1, 3, 4 and 6



Fig1. 8/20µs Pulse Waveform

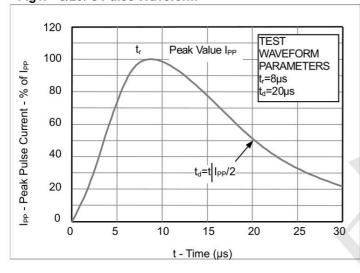


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

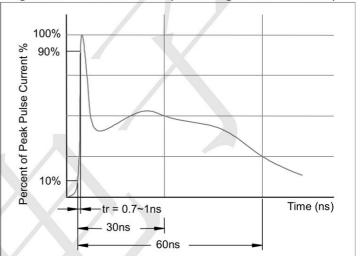
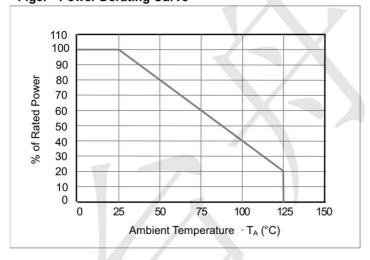
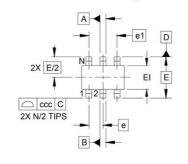


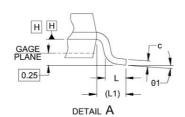
Fig3. Power Derating Curve

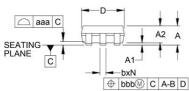




Outline Drawing - SOT23-6



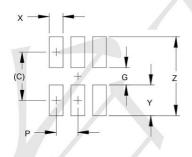






	- //	DIM	IENSI	ONS	1	
INCHES		MILLIMETERS				
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	.035	- 4	.057	0.90	12	1.45
A1	.000	-	.006	0.00	-	0.15
A2	.035	.045	.051	.90	1.15	1.30
b	.010	-	.020	0.25	10.70	0.50
С	.003	-)	.009	0.08	100	0.22
D	.110	.114	.118	2.80	2.90	3.00
E1	.060	.063	.069	1.50	1.60	1.75
Е	.110 BSC			2.80 BSC		
е	.037 BSC			0.95 BSC		
e1	.075 BSC			1	.90 BS	С
L	.012	.018	.024	0.30	0.45	0.60
L1	(.024)				(0.60)	7.0
N	6			- 4	6	
01	0°		10°	0°	-	10°
aaa	.004			-	0.10	
bbb	.008				0.20	
ccc	.008				0.20	

Land Pattern - SOT23-6



DIMENSIONS				
DIM	INCHES	MILLIMETERS		
С	(.098)	(2.50)		
G	.055	1.40		
Р	.037	0.95		
X	.024	0.60		
Y	.043	1.10		
Z	.141	3.60		